Overview

HP 250 G8 Notebook PC



Left

- 1. Internal microphone
- 2. Webcam LED
- 3. Webcam
- 4. Touchpad
- 5. Touchpad buttons
- 6. Audio combo jack

- 7. Power indicator LED
- 8. Hard drive indicator LED
- 9. USB-C® 3.2 Gen1 port (Data Transfer Only)
- 10. HDMI Port (Cable sold separately)
- 11. RJ-45 / Ethernet port
- 12. Power button



Overview



Right

- 1. Nano Security lock slot (Lock sold separately)
- 2. USB-A 3.2 Gen 1 port
- 3. USB-A 3.2 Gen 1 port

4. SD Card slot



Overview

At a Glance

- A new compact narrow bezel design with thinner & lighter chassis
- Preinstall with Windows 10 versions or FreeDOS
- Choice of 11th or 10th Generation Intel® Core™ i7, i5 and i3 processors and Intel® Pentium®, or Intel® Celeron® processors
- Choice of 39.62 cm (15.6") diagonal HD and FHD SVA Anti-Glare WLED or FHD IPS Anti-Glare WLED
- Optional NVIDIA GeForce MX130/MX330/MX450 discrete graphics with 2 GB GDDR5 video memory
- Security features including Firmware TPM 2.0
- Weight starting at 3.84 lbs (1.74 kgs)
- MM18 Battery life up to 9 Hours 50 mins ¹
- Wireless LAN (WLAN) up to 802.11ac or 802.11ax to keep you connected
- One USB 3.2 Gen 1 Type-C (Data Transfer Only), Two USB 3.2 Gen 1 Type-A
- Choice of Solid State Drives up to 1 TB and Hard Drive up to 2 TB
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 16 GB
- HP webcam with dual digital microphone and HD (supporting WDR- Wide Dynamic Range)

1. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.

NOTE: See important legal disclosures for all listed specs in their respective feature sections.



PRODUCT NAME

HP 250 G8 Notebook PC

OPERATING SYSTEMS

Preinstalled Windows 10 Pro 64 – HP recommends Windows 10 Pro¹

Windows 10 Pro 64 (National Academic only) 2

Windows 10 Home 64 1

Windows 10 Home Single Language 64 1

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

Supported Version

HP tested Windows 10, version 1809 on this platform For testing information on newer versions of Windows 10, please see: https://support.hp.com/document/c05195282.

PROCESSORS

Intel® Core™ i7-1165G7 processor with Intel® Iris® Xe Graphics (2.8 GHz base frequency, up to 4.7 GHz frequency with Intel® Turbo Boost Technology, 12 MB L3 cache, 4 cores) ^{3,4 5,6}

Intel® Core™ i5-1135G7 processor with Intel® Iris® Xe Graphics (2.4 GHz base frequency, up to 4.2 GHz frequency with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) 3,4 5,6

Intel® Core™ i3-1115G4 processor with Intel® UHD Graphics (3.0 GHz base frequency, up to 4.1 GHz frequency with Intel® Turbo Boost Technology, 6 MB L3 cache, 2 cores) 3,45,6

Intel® Core™ i7-1065G7 with Intel® Iris® Plus graphics (1.3 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 8 MB cache, 4 cores) ^{3,45,6}

Intel® Core™ i5-1035G1 processor with Intel® UHD Graphics (1.0 GHz base frequency, up to 3.6 GHz with Intel® Turbo Boost Technology, 6 MB cache, 4 cores) 3,45,6

Intel® Core™ i3-1005G1 processor with Intel® UHD Graphics (1.2 GHz base frequency, up to 3.4GHz with Intel® Turbo Boost Technology, 4 MB cache, 2 cores) 3,45,6

Intel® Pentium® Silver N5030 Processor with Intel® UHD Graphics 605 (1.1 GHz base frequency, up to 3.1 GHz burst frequency, 4 MB cache, 4 cores) ^{3,4,6}

Intel® Celeron® N4020 Processor with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.8 GHz burst frequency, 4 MB cache, 2 cores) 3,4,6

Intel® Pentium® Gold 7505 Processor with Intel® UHD Graphics (2.0 GHz base frequency, up to 3.5 GHz Standard, 4 MB cache, 2 cores) 3,4,6

Processors Family

11th Generation Intel® Core™ i7 processor (i7-1165G7) ⁷ 11th Generation Intel® Core™ i5 processor (i5-1135G7) ⁷

11th Generation Intel® Core™ i3 processor (i3-1115G4) 7

10th Generation Intel® Core™ i7 processor (i7-1065G7) 7

10th Generation Intel® Core™ i5 processor (i5-1035G1) 7

10th Generation Intel® Core™ i3 processor (i5-1005G1) ⁷

Intel® Pentium® Silver Processor (N5030) 7



Technical Specifications

Intel® Pentium® Gold Processor (7505) ⁷ Intel® Celeron® processor (N4020) ⁷

www.intel.com/technology/turboboost for more information.

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode. 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See
- 6. AMD Max Boost frequency performance varies depending on hardware, software and overall system configuration.
- 7. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Iris® Xe Graphics Intel® Iris® Plus graphics Intel® UHD Graphics Intel® UHD Graphics 605 Intel® UHD Graphics 600

Discrete

NVIDIA® GeForce® MX130 (2 GB DDR5 dedicated) 9 NVIDIA® GeForce® MX330 (2 GB DDR5 dedicated) 9 NVIDIA® GeForce® MX350 (2 GB DDR5 dedicated) 9

Supports

Support HD decode, DX12, HDMI 1.4b 8

- 8. HD content required to view HD images.
- 9. Integrated graphics depends on processor. NVIDIA® Optimus™ technology requires an Intel processor, plus an NVIDIA® GeForce® discrete graphics configuration and is available on Windows 10 Pro OS. With NVIDIA® Optimus™ technology, full enablement of all discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be).



DISPLAYS

Non-Touch

39.6 cm (15.6") diagonal, HD (1366 x 768), SVA , Anti-Glare WLED, 250nits, eDP micro-edge, 45% NTSC ^{8,10,11} 39.6 cm (15.6") diagonal, FHD (1920 x 1080), IPS, Anti-Glare WLED, 250nits eDP micro-edge, 45% NTSC ^{8,10,11} 39.6 cm (15.6") diagonal, FHD (1920 x 1080), SVA, Anti-Glare WLED, 250nits eDP micro-edge, 45% NTSC ^{8,10,11} **HDMI**

Port supports resolutions up to 1920 x 1080 external resolution @60 Hz

8. HD content required to view HD images.

10. Sold separately or as an optional feature.

11. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

Primary Storage

2 TB 5400 rpm SATA ¹² 1 TB 5400 rpm SATA ¹² 500 GB 7200 rpm SATA ¹² 500 GB 5400 rpm SATA ¹²

Primary M.2 Storage

128 GB M.2 SATA-3 TLC Solid State Drive ¹²
256 GB M.2 SATA-3 TLC Solid State Drive ¹²
256 GB PCle® NVMe™ M.2 Value Solid State Drive ¹²
512 GB PCle® NVMe™ M.2 Value Solid State Drive ¹²
512 GB PCle® NVMe™ M.2 TLC Solid State Drive ¹²
1 TB PCle® NVMe™ M.2 TLC Solid State Drive ¹²
1 TB PCle® NVMe™ M.2 Value Solid State Drive ¹²
256 GB Intel® PCle® NVMe™ QLC M.2 SSD with 16 GB Intel® Optane™ memory H10 ^{12,13,14}
512 GB Intel® PCle® NVMe™ QLC M.2 SSD with 32 GB Intel® Optane™ memory H10 ^{12,13,14}
2 TB 5400 rpm SATA with 16 GB Intel® Optane™ memory ^{12,13}
1 TB 5400 rpm SATA with 16 GB Intel® Optane™ memory ^{12,13}

Dual Storage

128 GB M.2 SATA-3 TLC Solid State Drive + 1 TB 5400rpm SATA ¹²
256 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive + 1 TB 5400rpm SATA ¹²

12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

13. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Requires 8th Gen or higher Intel® Core™ processor, BIOS version with Intel® Optane™ supported, Windows 10 64-bit, and an Intel® Rapid Storage Technology (Intel® RST) driver.

14. Intel® Optane™ memory H10 only for Intel® PCIe® NVMe™ QLC M.2 SSD.



Technical Specifications

MEMORY

Maximum Memory

16 GB DDR4-2666 SDRAM15

Memory

16 GB DDR4-2666 SDRAM (2 X 8 GB) ¹⁵
12 GB DDR4-2666 SDRAM (4 GB (1 x 4 GB) and 8 GB (1 x 8 GB) ¹⁵
8 GB DDR4-2666 SDRAM (1 x 8 GB) ¹⁵
8 GB DDR4-2400 SDRAM (1 x 8 GB) ¹⁵
8 GB DDR4-2666 SDRAM (2 x 4 GB) ¹⁵
4 GB DDR4-2666 SDRAM (1 x 4 GB) ¹⁵
4 GB DDR4-2400 SDRAM (1 x 4 GB) ¹⁵

Memory Slots

2 SODIMM (10th Generation Intel® Core™)
Supports Dual Channel Memory
1 SODIMM (Intel® Pentium®, Celeron® processors)

NOTE: All slots are customer non-accessible / non-upgradeable

15. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi® + Bluetooth® 5 ¹⁶
Realtek RTL8822CE 802.11a/b/g/n/ac (1x1) Wi-Fi® with Bluetooth® 4.2 Combo ¹⁶
Intel® Dual Band Wi-Fi 6 AX201 802.11a/b/g/n/ac/ax (2x2) WLAN and Bluetooth® 5 Combo, non-vPro® ¹⁷

Miracast

Compatible with Miracast-certified devices (For Win10) 18

Ethernet

Realtek 10/100/1000 GbE NIC 19

- 16. Wi-Fi supporting gigabit speeds (802.11ac) is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160MHz channels.
- 17. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.
- 18. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.
- 19. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.





AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated dual digital microphone

Camera

HP TrueVision HD Camera 8,10

Webcam¹⁰

8. HD content required to view HD images. 10. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

Full Size Textured island-style Keyboard

Pointing Device

Touchpad with multi-touch gesture support (PTP certified)

Function Keys

F1 - Open " How to get help in Windows 10" webpage

F2 - Brightness Down

F3 - Brightness Up

F4 - Display Switching

F5 - Blank

F6 - Mute

F7 - Volume Down

F8 -Volume Up

F9 - Previous

F10 - Play/Pause

F11 - Next

F12 - Airplane mode

SOFTWARE AND SECURITY

Preinstalled Software Software

HP Support Assistant 20

Native Miracast Support 21

HP documentation

HP Setup Integrated 00BE

HP SSRM

HP Audio Switch

HP JumpStarts

McAfee LiveSafe™ 19

Xerox® DocuShare® 90 day free trial offer29

Security Management





Firmware TPM 2.0 22

- 19. 30 days free trial
- 20. HP Support Assistant requires Windows and Internet access.
- 21. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.
- 22. Firmware TPM is version 2.0. which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).32. Firmware TPM is version 2.0.
- 29. Simply sign up and start using Xerox® DocuShare® Go. No credit card. No obligation. Data will become unavailable unless a subscription is entered before the end of the 90 day free trial period. See visit www.xerox.com/docusharego for details.

POWER

Power Supply

HP Smart 65 W External AC power adapter ²³ HP Smart 65 W EM External AC power adapter ²³ HP Smart 45 W External AC power adapter ²³

Primary Battery

HP Long Life 3-cell, 41 Wh Li-ion 24

Power Cord

1M (3.28 feet) length power cord

MM18 Battery life

Up to 9 Hours 50 mins 25

Battery Weight

0.19 kg 0.42 lb

- 23. Availability may vary by country.
- 24. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 25. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Product Weight 26

Starting at 3.84 lb Starting at 1.74 kg

Product Dimensions (w x d x h)

14.09 x 9.53 x 0.78 in 35.8 x 24.2 x 1.99 cm

26. Weight will vary by configuration. Does not include power adapter.



Technical Specifications

PORTS/SLOTS

Ports

2 USB-A 3.2 Gen1 1 USB Type-C[®] 3.2 Gen1 (Data Transfer Only) 1 HDMI v1.4b ²⁷ 1 RJ-45 1 AC Power

Expansion Slots

Support SD/SDHC/SDXC 1 Multi-format digital media reader

1 Headphone/microphone combo jack

27. HDMI cable sold separately.

SERVICE AND SUPPORT

1-year limited warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.28

28. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC

Power)

Nominal Operating Voltage 19.5 V Average Operating Power TBD Integrated graphics 6.37W

Discrete Graphics N/A (Switchable graphics design)

Max Operating Power Discrete < 65W UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (writing optical)

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%

Shock

Operating 40 G, 2 ms, half-sine Non-operating 240 G, 2 ms, half-sine

Random Vibration

Operating 1.043 grms Non-operating 3.5 grms

Altitude (unpressurized)

Operating -15 m to 3048 m (-50 ft to 10000 ft) Non-operating -15 m to 12192 m (-50 ft to 40000 ft)

No

No

Planned Industry Standard

Certifications Yes UL No CSA Yes **FCC Compliance** Yes **ENERGY STAR®** Yes **EPEAT®** Yes **ICES** No Australia / No NZ A – Tick Compliance CCCYes No Japan VCCI Compliance No KC Yes **BSMI** Yes **CE Marketing Compliance** No **BNCI or BELUS** No CIT



GOST

Saudi Arabian Compliance (ICCP)



SABS No UKRSERTCOMPUTER No

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 15.6 inch FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR slim NWBZ **Outline Dimensions (W x H x D)** 350.96 x 216.75 (max.) x 3.2 (max.) mm

Active Area 344.16 x 193.59 mm

Weight 370g max.

Diagonal Size 15.6"

Surface Treatment AG

Touch enabled None

Contrast Ratio 600:1 (typ.)

Refresh Rate 60Hz

Brightness 250nits typ.

Pixel Resolution

Configuration1920 x 1080 (FHD)InterfaceeDP 1.2 w/o PSRLCD ModeIPS/PLS/AHVA

PPI 142

Viewing Angle UWVA 85/85/85

Panel LCD 15.6-in FHD (1920x1080) Anti-Glare WLED SVA 45percent cg 250nits eDP 1.2 w/o PSR NWBZ ultraslim **Outline Dimensions (W x H x D)** 350.96 x 216.75 (max.) x 3.2 (max.) mm

Active Area 344.16 x 193.59 mm

Weight 360g max.

Diagonal Size 15.6"

Surface Treatment AG

Touch enabled None

Contrast Ratio 300:1 (typ.)

Refresh Rate 60Hz

Brightness 250nits typ.

Pixel Resolution

Configuration1920 x 1080 (FHD)InterfaceeDP 1.2 w/o PSR

LCD Mode TN PPI 142

Viewing Angle UWVA 45/45/15/35



Technical Specifications

Panel LCD 15.6-in HD (1366x768) Anti-Glare WLED SVA 45percent cg 250nits eDP 1.2 w/o PSR NWBZ ultraslim **Outline Dimensions (W x H x D)** 351.03 x 216.75 (max.) x 3.2 (max.) mm

Active Area 344.23 x 193.54 mm

Weight 360g max.
Diagonal Size 15.6"
Surface Treatment AG
Touch enabled None
Contrast Ratio 300:1 (typ.)
Refresh Rate 60Hz
Brightness 250nits typ.

Pixel Resolution

Configuration1366 x 768 (HD)InterfaceeDP 1.2 w/o PSR

LCD Mode TN PPI 101

Viewing Angle UWVA 40/40/15/30



Technical Specifications

STORAGE AND DRIVES*

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

HDD 1TB 5400RPM 7mm SATA (HDD 1TB 5400RPM 2.5in) **Drive Weight** 0.21 lbs (95 g)

Capacity 1TB

Height 0.28 in (7 mm)
Width 2.75 in (69.85 mm)
Interface ATA-8, SATA 3.0
Maximum Sequential Read Up to 100 MB/s
Maximum Sequential Write Up to 100 MB/s
Logical Blocks 1,953,525,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features S.M.A.R.T., NCQ, Ultra DMA

HDD 2TB 5400RPM 7mm SATA 2.5in (HDD 2TB 5400RPM SATA 2.5in 2nd) **Drive Weight** 0.21 lbs (95 g)

Capacity 2TB

Height Up to 128MB
Width 0.28 in (7 mm)
Interface 2.75 in (69.85 mm)
Maximum Sequential Read Up to 100 MB/s
Maximum Sequential Write Up to 100 MB/s
Logical Blocks 3,907,029,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features S.M.A.R.T., NCQ, Ultra DMA

HDD 500GB 5400RPM 7mm SATA **Drive Weight** 0.21 lbs (95 g)

Capacity 500GB

Height 0.28 in (7 mm)
Width 2.75 in (69.85 mm)
Interface ATA-8, SATA 3.0
Maximum Sequential Read Up to 100 MB/s
Maximum Sequential Write Up to 100 MB/s
Logical Blocks 976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features S.M.A.R.T., NCQ, Ultra DMA



HDD 500GB 7200RPM 7mm **SATA (HDD 500GB 7200RPM**

2.5in)

Drive Weight 0.21 lbs (95 q)

Capacity 500GB

Height 0.28 in (7 mm) Width 2.75 in (69.85 mm) Interface ATA-8. SATA 3.0 **Maximum Sequential Read** Up to 120 MB/s

Logical Blocks 976,773,168

Maximum Sequential Write

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Up to 120 MB/s

Features S.M.A.R.T., NCQ, Ultra DMA

SSD 128GB 2280 M2 SATA-3 Drive Weight TLC (SSD 128GB 2280 M2

SATA-3 TLC)

0.01 lb (6 q) ~ 0.02 lb (10 q)

Capacity 128 GB

Height 0.09 in (2.3 mm) Width 0.87 in (22 mm) Interface ATA-8, SATA 3.0 **Maximum Sequential Read** Up to 100MB/s **Maximum Sequential Write** Up to 400MB/s **Logical Blocks** 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

SSD 1TB 2280 PCIe NVMe Value (SSD 1TB 2280 PCIe

NVMe Value)

Drive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 1TB

Height 0.09 in (2.3 mm) Width 0.87 in (22 mm) Interface PCIe NVMe Gen3X2 **Maximum Sequential Read** Up to 1500MB/s **Maximum Sequential Write** Up to 750MB/s **Logical Blocks** 2,000,409,264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features L1.2



SSD 16GB 2280 PCIe-3x2 NVMe 3D Xpoint (SSD 16GB 2280 PCIe-3x2 NVMe 3D Xpoint) **Drive Weight** 0.01 lb (6 g) \sim 0.02 lb (10 g)

Capacity 16GB

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X2

Maximum Sequential Read900MB/sMaximum Sequential Write145MB/sLogical Blocks28,181,188

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM, L1.2

SSD 256GB 2280 M2 SATA-3 Drive Weight TLC (SSD 256GB 2280 M2 Capacity SATA-3 Three Layer Cell)

Drive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 256GB

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X2Maximum Sequential ReadUp to 2900 MB/sMaximum Sequential WriteUp to 1100 MB/sLogical Blocks500,118,191

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

SSD 256GB 2280 PCIe NVMe Drive Weight
Value (SSD 256GB 2280 Capacity
PCIe NVMe Value)

Orive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 256GB

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3X2
Maximum Sequential Read Up to 1500MB/s
Maximum Sequential Write Up to 750MB/s
Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM, L1.2



SSD 256GB 2280 PCIe-3x2x2 NVMe+SSD 16GB 3D Xpoint (SSD 256GB 2280 PCIe-3x2x2 NVMe +SSD 16GB 3D Xpoint) **Drive Weight** 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 256GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X2

Maximum Sequential Read1450MB/sMaximum Sequential Write500MB/sLogical Blocks500,188,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM, L1.2

SSD 512GB 2280 M2 PCIe-3x4 SS NVMe TLC (SSD 512GB M.2 2280 PCIe NVMe Three Layer Cell w/Caddy 2nd) **Drive Weight** 0.01 lb (6 g) \sim 0.02 lb (10 g)

Capacity 512GB

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X2Maximum Sequential ReadUp to 3000MB/sMaximum Sequential WriteUp to 150MB/sLogical Blocks1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM, L1.2

Drive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 512GB

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3X2
Maximum Sequential Read Up to 1500MB/s
Maximum Sequential Write Up to 750MB/s
Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM, L1.2



SSD 512GB 2280 PCIe NVMe Drive Weight Value (SSD 512GB 2280 Capacity

PCIe NVMe Value)

Drive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 512GB

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3X2
Maximum Sequential Read Up to 1500MB/s
Maximum Sequential Write Up to 750MB/s
Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM, L1.2

SSD 512GB 2280 PCIe-3x2x2 NVMe+SSD 32GB 3D Xpoint (SSD 512GB 2280 PCIe-3x2x2 NVMe +SSD 32GB 3D Xpoint) **Drive Weight** 0.01 lb (6 g) \sim 0.02 lb (10 g)

Capacity 512GB

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X2

Maximum Sequential Read2400MB/sMaximum Sequential Write1300MB/sLogical Blocks1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM. L1.2

NETWORKING/COMMUNICATIONS

Intel® Wi-Fi 6 AX201 + Bluetooth® 5 (802.11ax 2x2, non-vPro®, supporting gigabit file transfer speeds) non-vPro®1,2 Wireless LAN Standards IEEE 802.11a

IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11d
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r
IEEE 802.11r

Interoperability Features Wi-Fi® 6 technology

Frequency Band • 802.11b/g/n/ax

2.402 – 2.482 GHz • 802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps



802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

• 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz &

160MHz)

 \bullet 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

• IEEE compliant 64 /128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationIEEE 802.11iWAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

• 802.11b: +18.5dBm minimum

802.11b: +18.5dBm minimum
802.11g: +17.5dBm minimum
802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum

802.11ac VHT160(5GHz): +11.5dBm minimum
802.11ax HT40(2.4GHz): +10dBm minimum
802.11ax VHT160(5GHz): +10dBm minimum

Power Consumption

Transmit mode: 2.0 W

Receive mode:1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
 Idle mode: 50 mW (WLAN unassociated)
 Connected Standby/Modern Standby: 10mW

· Radio disabled: 8 mW

Power Management

ACPI and PCI Express compliant power management 802.11 compliant power saving mode

Receiver Sensitivity⁵

802.11b, 1Mbps: -93.5dBm maximum
802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum

802.11ac, MCS0: -84dBm maximum
802.11ac, MCS9: -59dBm maximum
802.11ax, MCS11(HT40): -59dBm maximum

• 802.11ax, MCS11(VHT160): -58.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

Dimensions 1. Type 2230: 2.3 x 22.0 x 30.0 mm



Technical Specifications

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8 g

2. Type 126: 1.3 g

3.3v +/- 9%

Operating Voltage

Temperature Operating

> Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing)

Operating 0 to 10.000 ft (3.048 m)

Altitude Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF

LED Off - Radio ON

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.

14° to 158° F (-10° to 70° C)

2. Wi-Fi supporting gigabit speeds is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160MHz channels.

3. Check latest software/driver release for updates on supported security

4. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

5. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz **Number of Available** Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate⁶ 2.17 Mbps

BLE: 1 Mbps signaling data rate⁶ 0.2 Mbps

6. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 9.5 dBm for BR and EDR.



Realtek

802.11a/b/g/n/ac (1x1) Wi-Fi® and Bluetooth® 4.2 Combo¹ Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac

IEEE 802.11d IEEE 802.11d IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11r

Interoperability Wi-Fi certified modules

Frequency Band 802.11b/g/n

• 2.402 – 2.482 GHz 802.11a/n/ac

4.9 – 4.95 GHz (Japan)
5.15 – 5.25 GHz
5.25 – 5.35 GHz
5.47 – 5.725 GHz
5.825 – 5.850 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

• 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

IEEE 802.11 compliant roaming between access points

WPA2 certificationIEEE 802.11iWAPI

Network Architecture

Models

Roaming

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Output Power³ • 802.11b: +14dBm minimum

• 802.11g : +12dBm minimum • 802.11a : +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum
802.11n HT40(2.4GHz): +12dBm minimum
802.11n HT20(5GHz): +10dBm minimum
802.11n HT40(5GHz): +10dBm minimum
802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption • Transmit mode: 2.0 W

• Receive mode: 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

· Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management



Technical Specifications

802.11 compliant power saving mode

Receiver Sensitivity⁴ • 802.11b, 1Mbps: -93.5dBm maximum

• 802.11b, 11Mbps: -84dBm maximum • 802.11a/q, 6Mbps: -86dBm maximum 802.11a/q, 54Mbps: -72dBm maximum 802.11n. MCS07: -67dBm maximum • 802.11n, MCS15: -64dBm maximum

• 802.11ac. MCS0: -84dBm maximum • 802.11ac, MCS9: -59dBm maximum

High efficiency antenna with spatial diversity, mounted in the display Antenna type

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Weight Type 2230: 2.8q 3.3v +/- 9% **Operating Voltage**

Temperature Operating 14° to 158° F (-10° to 70° C)

> Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10.000 ft (3.048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF LED Off - Radio ON

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11
- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant **Frequency Band** 2402 to 2480 MHz

Number of Available

Channels

Data Rates and

Throughput

Legacy: 0~79 (1 MHz/CH)BLE: 0~39 (2 MHz/CH)

Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)



Technical Specifications

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi®+ Bluetooth® 5¹ **Wireless LAN Standards**

IEEE 802.11a

IEEE 802.11b

IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

IEEE 802.11d

IEEE 802.11e

IEEE 802.11h

IEEE 802.11i

IEEE 802.11k IEEE 802.11r

IEEE 802.11v

Interoperability

Wi-Fi certified modules

Frequency Band

802.11b/g/n

• 2.402 – 2.482 GHz

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• 4.9 – 4.95 GHz (Japan)

5.15 – 5.25 GHz

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5.825 – 5.850 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps

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802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

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BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• IEEE 802.11i

WAPI

Network Architecture

Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power³ • 802.11b: +18.5dBm minimum

• 802.11g : +17.5dBm minimum

• 802.11a: +18.5dBm minimum

• 802.11n HT20(2.4GHz): +15.5dBm minimum

• 802.11n HT40(2.4GHz): +14.5dBm minimum

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• 802.11n HT40(5GHz): +14.5dBm minimum

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Power Consumption

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Receive mode: 1.6 W



Technical Specifications

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

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2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230 : 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

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HP Integrated Module with Bluetooth® 4.0/4.1/4.2/5.0 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0 Compliant

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Number of Available Legacy : 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)





Data Rates andLegacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

POWER

AC Adapter 45 Watt Smart Dimensions (H x W x D)

nPFC Standard Barrel 4.5mm Right Angle 1.8m 101.1.1.1

Weight

95.0x40.0x26.5mm unit: 200g +/- 10g

Input Efficiency 87.74 % at 115 Vac and 88.4 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.4 A at 90 Vac

Output Output power 45W

DC output 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit <8.0A

Connector C6 (3pin/with grounded, with Smart ID DC connector)

Environmental Design Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

Storage Humidity 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

Certifications

New EM

Weight unit: 250g +/- 10g

Input Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output Output power 65W

DC output 19.5V

Hold-up time 5ms at 115 Vac input



Technical Specifications

Output current limit <11.0A

Connector C6 (3pin/with grounded, with Smart ID DC connector)

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.
MTBF - over 200.000 hours at 25°C ambient condition.

AC Adapter 65 Watt Smart Dimensions nPFC Standard Barrel 4.5mm Right Angle 1.8m

 Dimensions
 90.0x51x28.5mm

 Weight
 unit: 230q +/- 10q

Certifications

Input Input Efficiency 88.0 % at 115 Vac and 89.0% at 230Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output Output power 65W

DC output 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit <11.0A

ConnectorC6 (3pin/with grounded, with Smart ID DC connector)Environmental DesignOperating32°F to 95°F (0°to 35°C)

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Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

Battery HT 3 Cell WHr 41 Long Life -PR+PL Fast Charge (Battery 3 Cell **Dimensions** 6.0mm x 186.85mm x 90.2mm

Weight 192g

Cells/Type 3cell Lithium-Ion Prismatic cell / 496080



WHr 41 Long Life -PR+PL Energy

Fast

Voltage 11.55V

Amp-hour capacity 3615mAh

Watt-hour capacity 41Wh

Temperature Operating (Charging) $0^{\circ}\text{C} \sim 45^{\circ}\text{C}$

Operating (Discharging) -10°C ~ 60°C

Fuel Gauge LED N/A

Warranty 1000 cycles > 65% (at 23°C)

Optional Travel Battery

Available

No



Technical Specifications

FINGERPRINT READER

Model Elan eFSA80ST touch sensor

Mobile Voltage Operation 2.65V to 3.6V

Operating Temperature: 32° to 95° F (0° to 35° C)

Current Consumption Image:50mA peakLow Latency Wait For Finger<900 uA</th>Capture Rate: Image transmitter output frequency20cm/sec

ESD Resistance IEC 61000-4-2 (+15KV)

Detection Matrix 508 dpi / 4x4mm sensor area

FRR (False Reject Rate) / FAR (False Acceptance Rate) FRR ~ 2% @ 1:50K FAR

Country of Origin

China





Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Prelude Pro Top Load	1X645AA
	HP Prelude Pro Backpack	1X644AA
	HP Prelude Top Load 15.6	1E7D7AA
	HP Prelude Backpack 15.6	1E7D6AA
Docking	HP USB-C®/A Universal Dock G2	5TW13AA
	HP 4.5 mm and USB-C®Dock Adapter G2	6LX61AA
Input/Output	HP USB Essential Keyboard/Mouse	H6L29AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Slim Wireless Keyboard & Mouse	T6L04AA
	HP Wired Desktop 320K Keyboard	9SR37AA
	HP Slim Wireless Keyboard (Link-5)	T6U20AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP Essential USB Mouse	2TX37AA
	HP USB Travel Mouse	G1K28AA
	HP Bluetooth Travel Mouse	6SP30AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Wired Desktop 320M Mouse	9VA80AA
	HP HDMI to VGA Adapter	H4F02AA
	HP HDMI to DVI	F5A28AA
Power	HP 45W Smart AC Adapter	H6Y88AA
	HP 65W Smart AC Adapter	H6Y89AA
	HP 65W Slim Adapters (w/ detachable DC cable + TIPS)	H6Y82AA
Storage	HP External USB Optical Drive	F2B56AA



Summary of Changes

Date of change:	Version History:	Description of change:
	V1 to V2	

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